

mm-Wave and sub-Terahertz Antennas for 5G and 6G Applications

Students: Kai-Qi Huang, Serhat Erdoğan, and Muhammad Ali
Faculty: Dr. Madhavan Swaminathan, and Dr. Fuhan Liu

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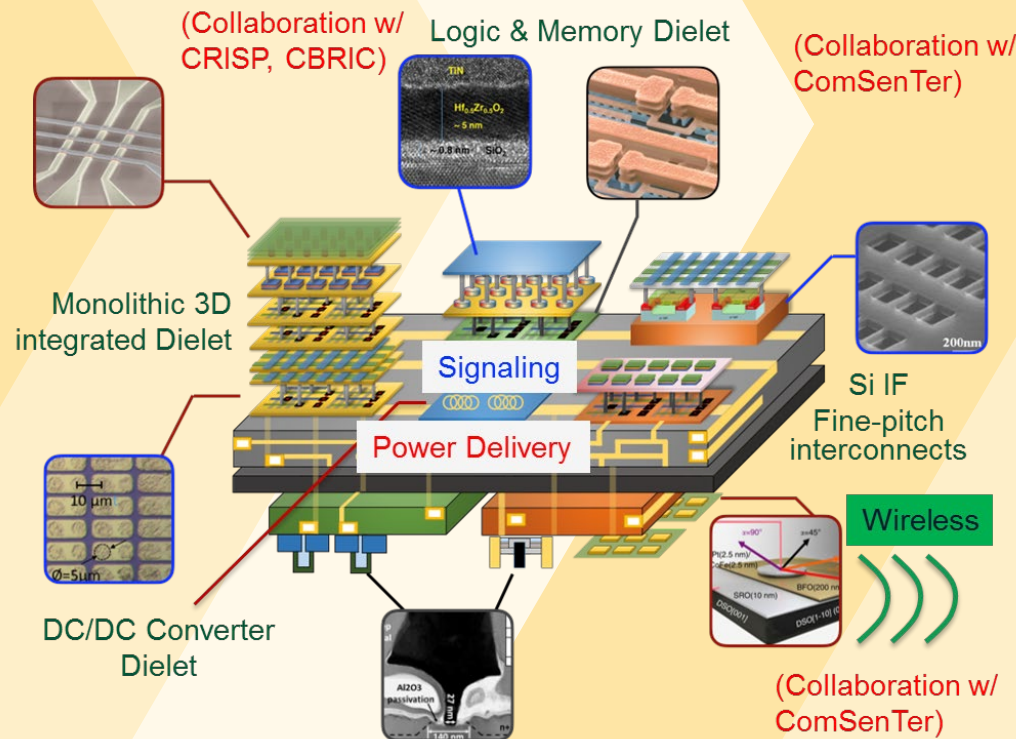
This work was being developed with PRC and C³PS at the Georgia Institute of Technology.

Special thanks to the following current and former liaisons of our task at ASCENT: Ashish Agrawal (Intel), Dan Blass (Lockheed Martin), Henning Braunisch (Intel), Tsu-Hsi Chang (DARPA), Brian Doyle (Intel), Xiaoxiong Gu (IBM), Augusto L. Gutierrez-Aitken (Northrop Grumman), Nazila Haratipour (Intel), Jack T. Kavalieros (Intel), Elizabeth Kunkee (Northrop Grumman), Ravi Pillarisetty (Intel), Willy Rachmady (Intel), Kun Si (EMD Perform. Matls.), Abhishek A. Sharma (Intel), Shriram Shivaraman (Intel), and Seung Hoon Sung (Intel)

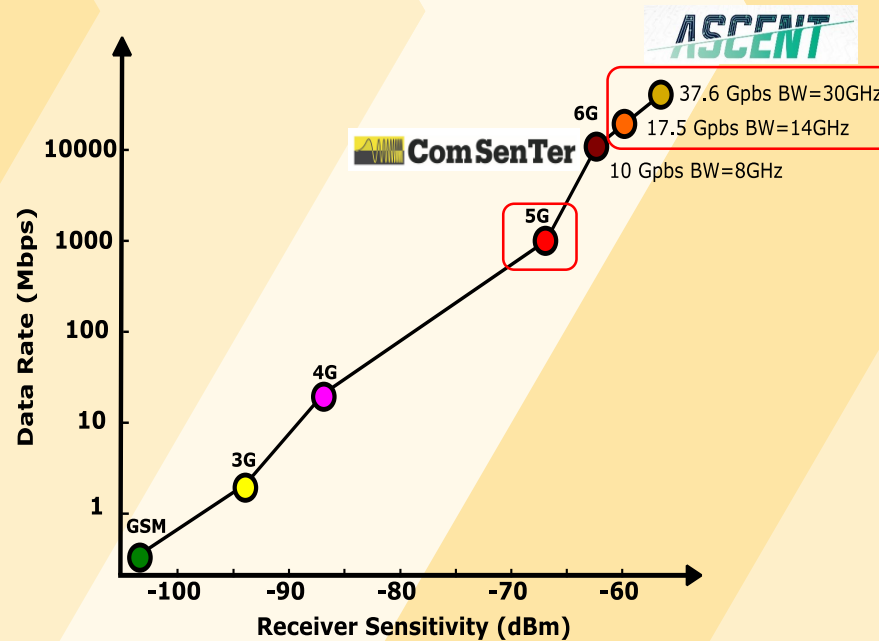
We should like to acknowledge the collaboration of ComSenTer, another centre in JUMP, on terahertz radio applications.

We also appreciate the assistance of GEDC and GEMS at Georgia Tech with antenna measurements.

- ❑ ASCENT task — Antenna integration and miniaturization
 - ❑ Antenna as a key component of integrated RF front-end dielets
 - ❑ Interface of a high-performance microsystem to the space
 - ❑ mm-Wave to THz bands for 5G/6G+ wireless communications
 - ❑ High-gain antenna solution integrated on glass-based panels



- ❑ Design, fabricate, and prototype antennas that:
 - ❑ Work at mm-wave to sub-terahertz frequency bands for 5G/6G wireless applications
 - ❑ Support >15% bandwidth at 140 GHz band
 - ❑ Provide high gain
 - ❑ Have 20% reduced antenna size compared to typical designs
 - ❑ Have high efficiency

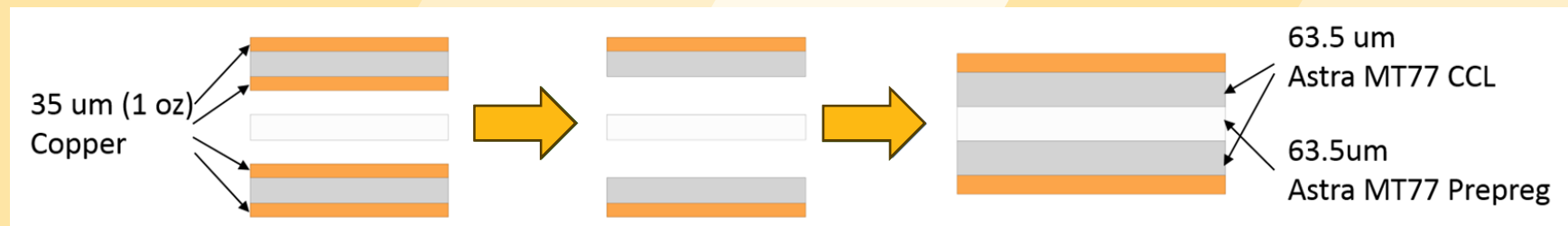


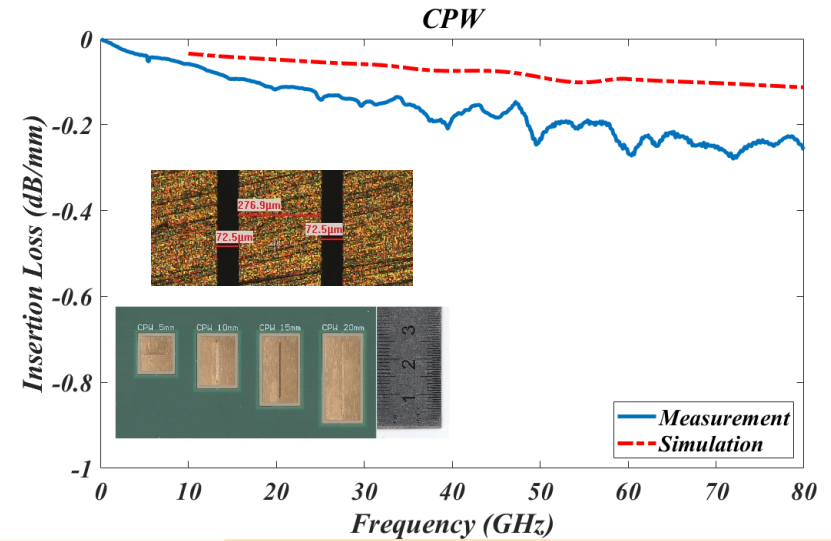
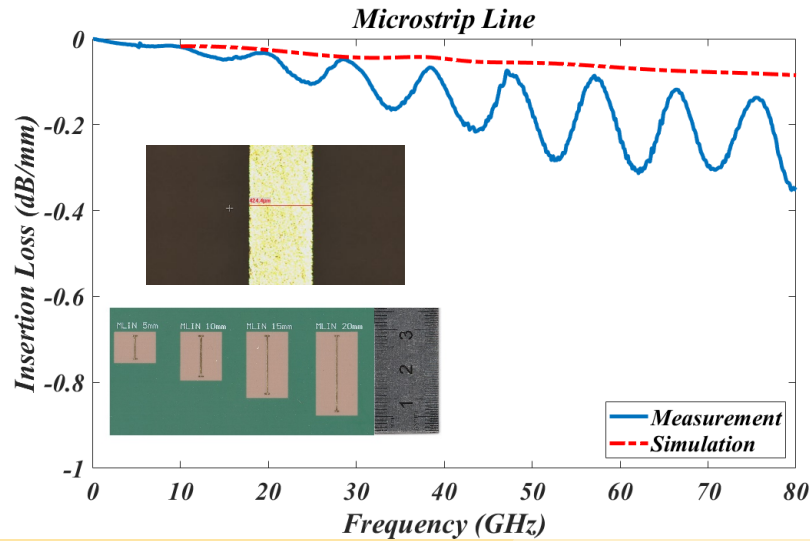
❑ Laminate substrate

- ❑ For <200GHz applications
- ❑ Low and stable permittivity
Dk=3.0
- ❑ Low loss tangent Df=0.0017
- ❑ Vendor fabrication and Georgia Tech (process being developed)

❑ Fan-Out Panel-Level Packaging (FOPLP)

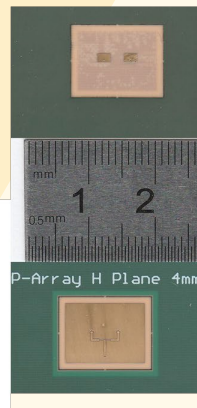
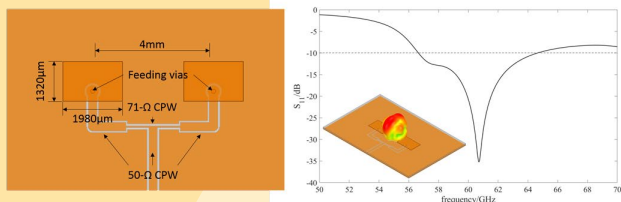
- ❑ For >100GHz applications
- ❑ Moderately low permittivity and loss tangent Df~0.005
- ❑ Fabrication process being developed





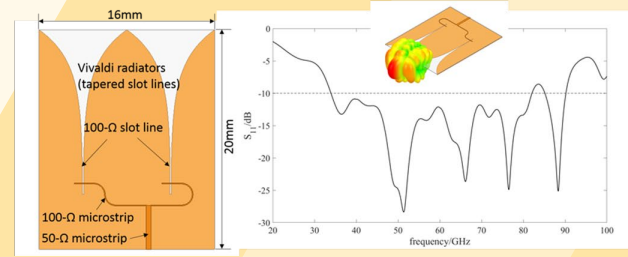
Patch Antennas

- Example: Patch Array
 - Patch size: 1380µm(L) x 2070µm(W)
 - Element distance: 4mm
 - Resonance frequency: 60.07GHz
 - Bandwidth: 8.11GHz (13%)
 - Broadside gain: 9.3dBi

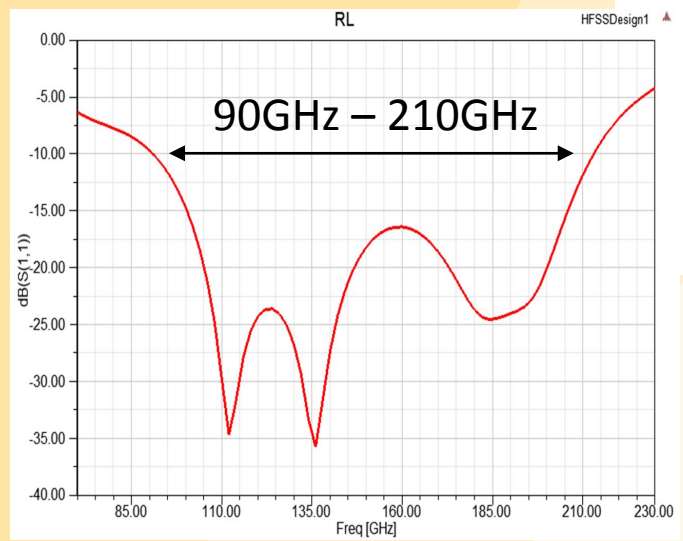
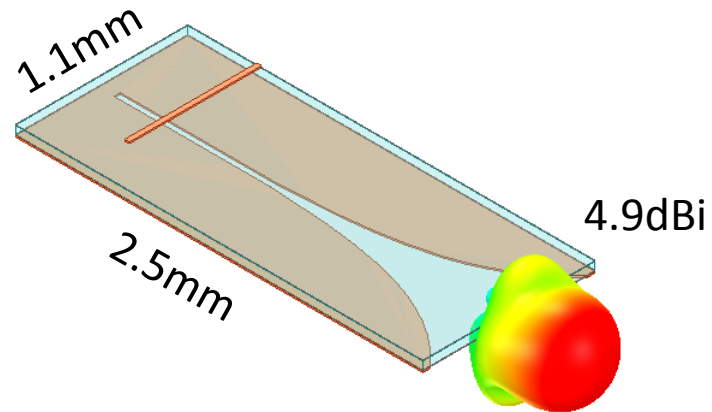


Vivaldi Antennas

- Example: Vivaldi Array
 - Size: 16mm x 20mm
 - Bandwidth: 33.9GHz – 82.1GHz
 - Gain: 11.5dBi @ 60GHz

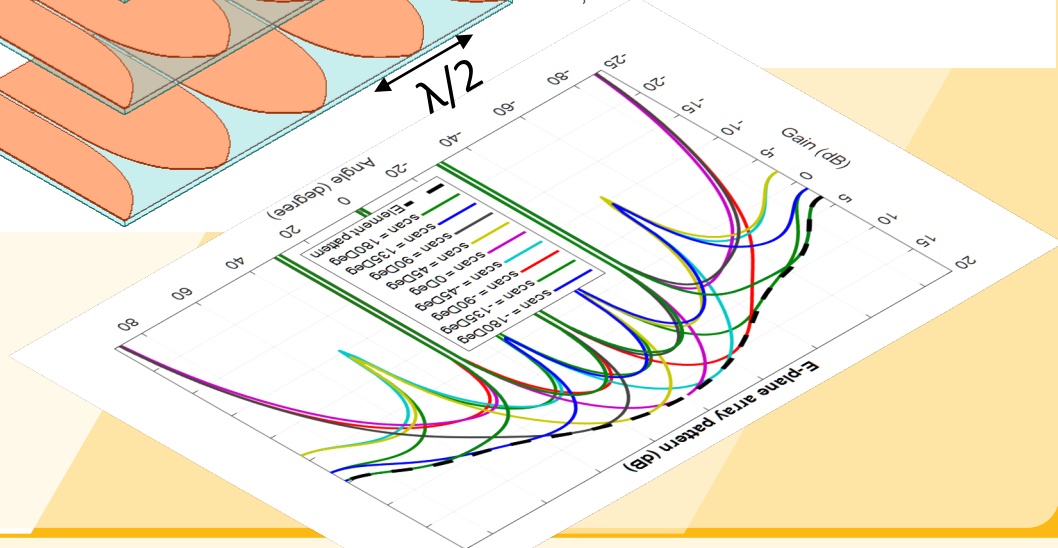
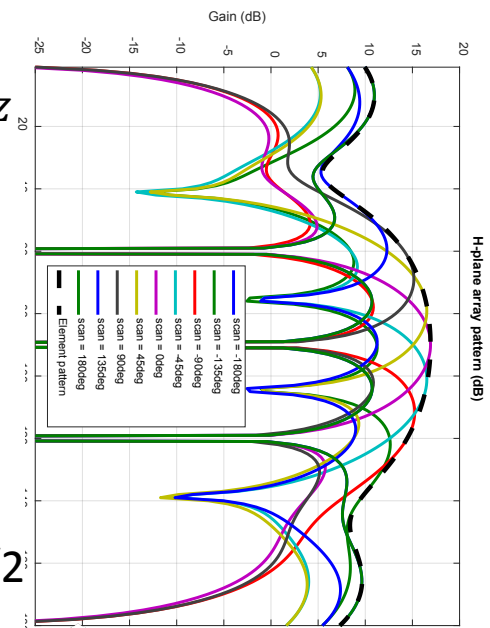
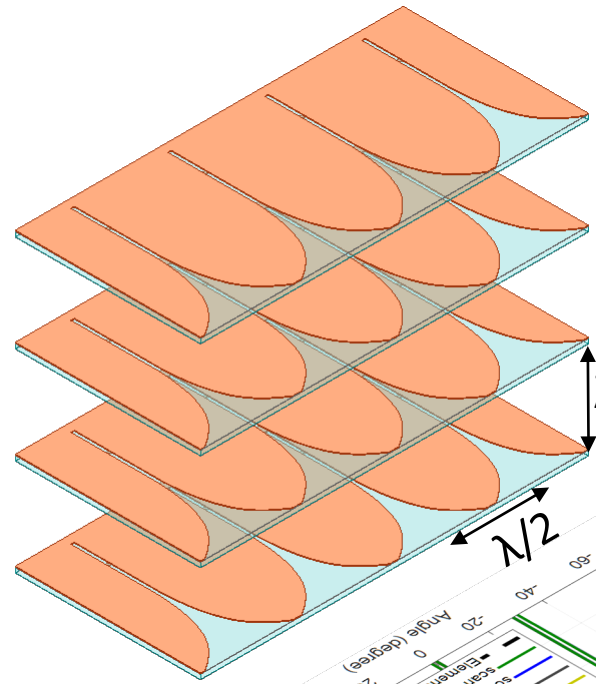


Antenna element

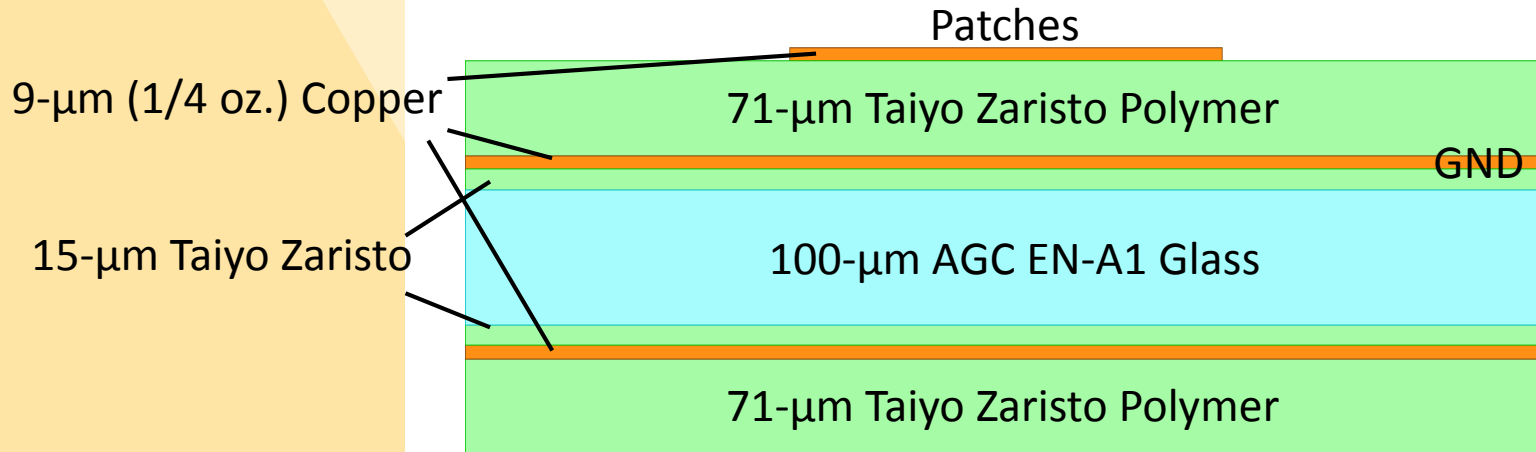


4x4 Array

$\lambda/2 \cong 1.1\text{mm} @ 140\text{GHz}$



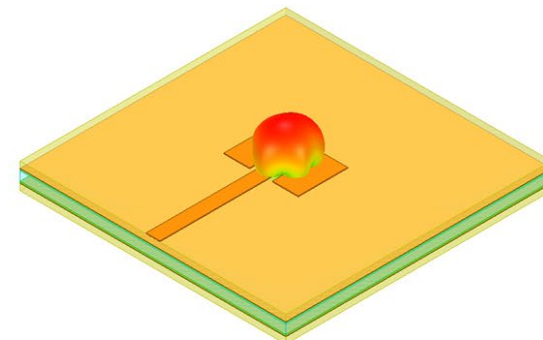
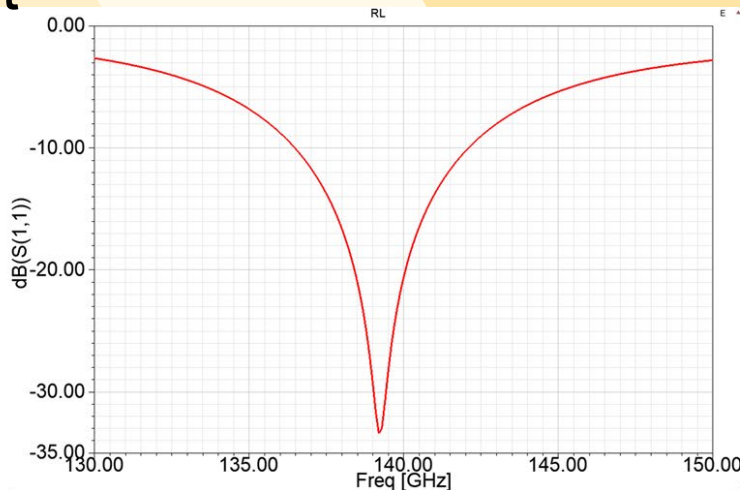
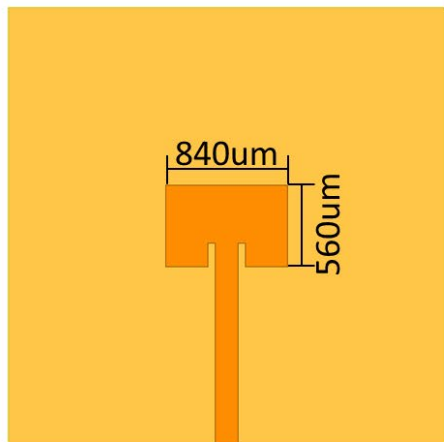
Stack-up of the test vehicle



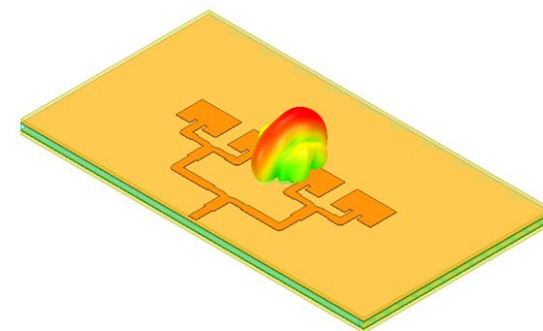
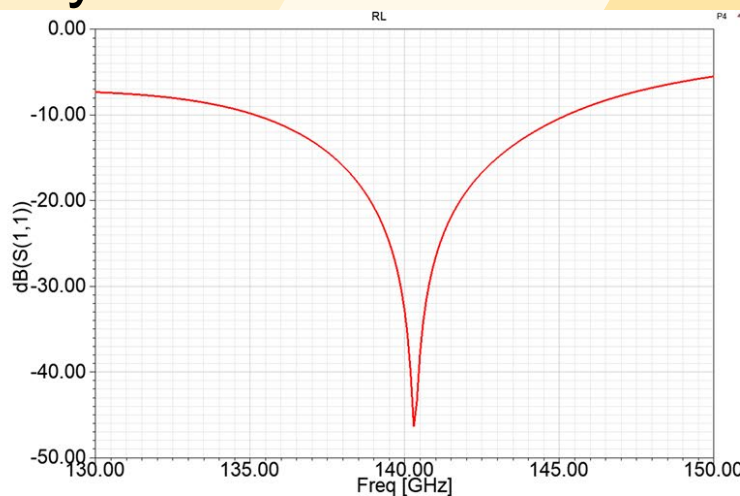
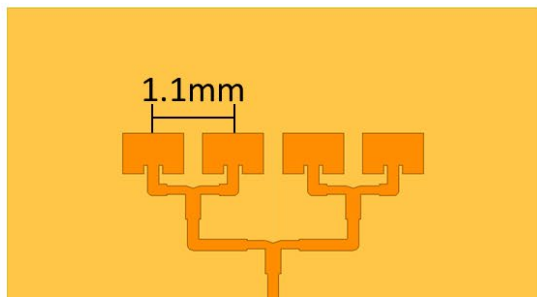
Material properties

Material	Dk	Df
Glass (AGC EN-A1)	5.4	0.005
Polymer (Taiyo Zaristo)	3.3	0.0025

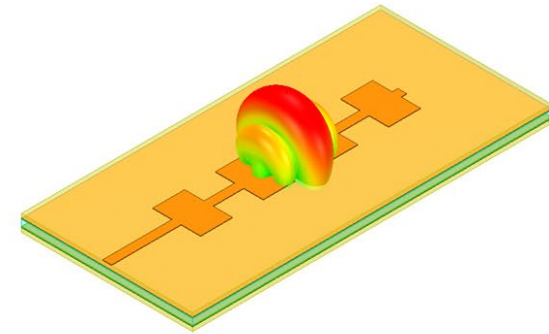
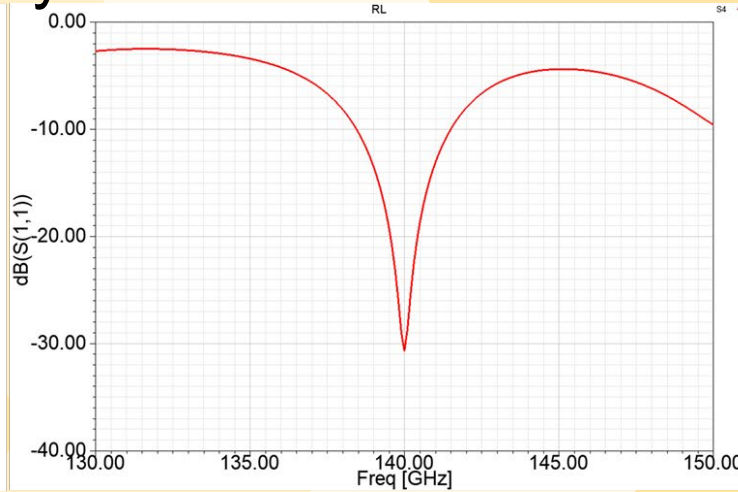
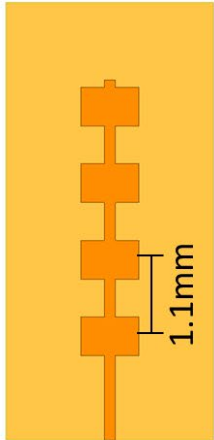
□ Patch element



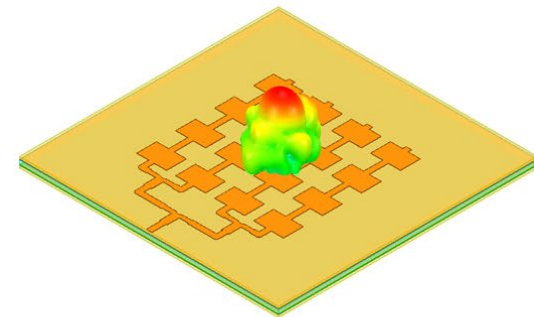
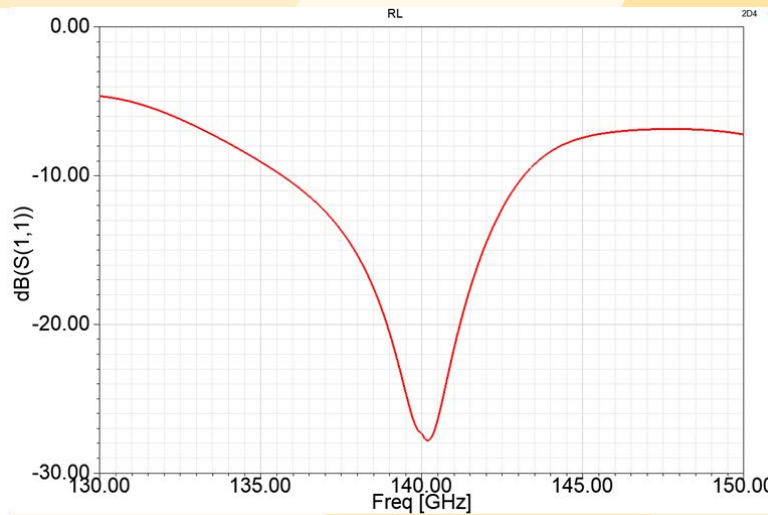
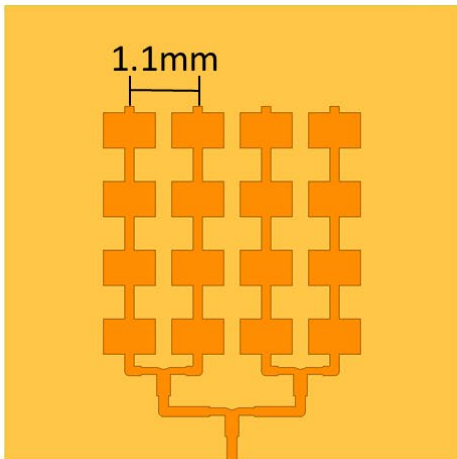
□ Parallel-fed array

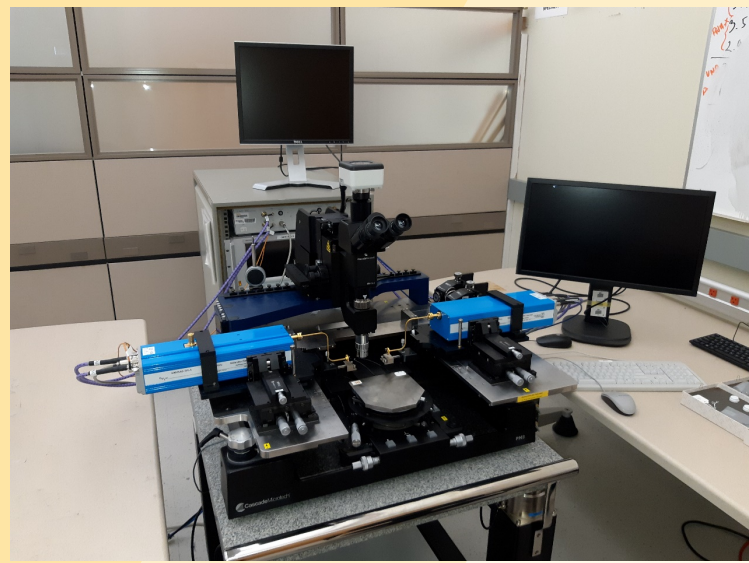
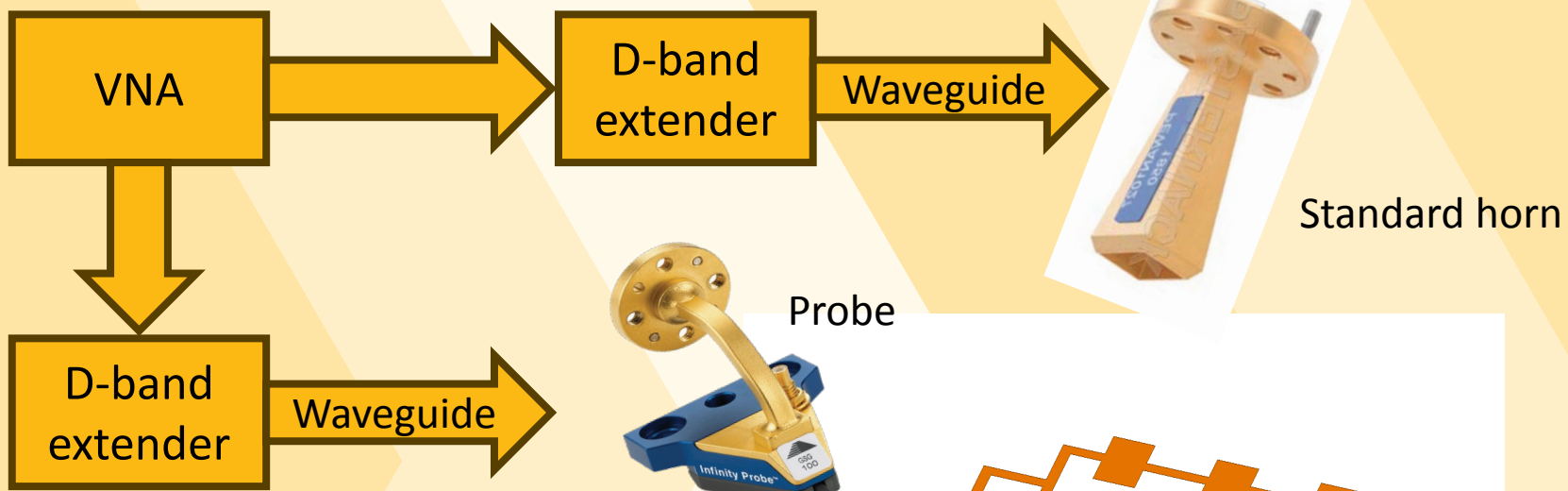


Series-fed array



2-D array





D-band measurement equipment at GEDC

- ❑ Fabrication difficulties of 3-D fine structures
- ❑ Broadband matching of the antenna feeding network
- ❑ Substrate modes as the wavelength is comparable to substrate thickness at sub-THz frequency
- ❑ Coupling between elements is complicated in a large array consisting of numerous elements
- ❑ mm-Wave and sub-THz antenna measurement

- ❑ Develop the complete fabrication process of laminate substrate and the FOPLP process on glass substrate
- ❑ Continuously design and fabricate new structures to test the concept and the process
- ❑ Design wide-band low-loss feeding network using SIW's
- ❑ Investigate the design and fabrication of 3-D high-gain antennas such as horn antennas
- ❑ Develop a reliable antenna measurement method beyond 100 GHz

'19 Q4	'20 Q1	'20 Q2	'20 Q3	'20 Q4
Fabrication Process				
Test Structure Tape-Out				
	SIW Antennas and Feeding Network			
				3-D Antennas
Measurement Method				

- ❑ Antenna at mm-wave and sub-terahertz bands for 5G/6G RF front-end
- ❑ Fabrication of antenna dielects using organic laminate substrate and glass FOPLP
- ❑ Test structures fabricated on Astra substrate for 5G applications at 60 GHz band
- ❑ Antenna design based on glass stack-up for 6G applications at 140 GHz
- ❑ mm-Wave and sub-THz antenna measurement